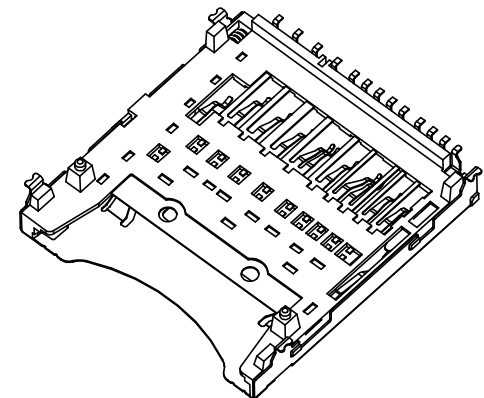
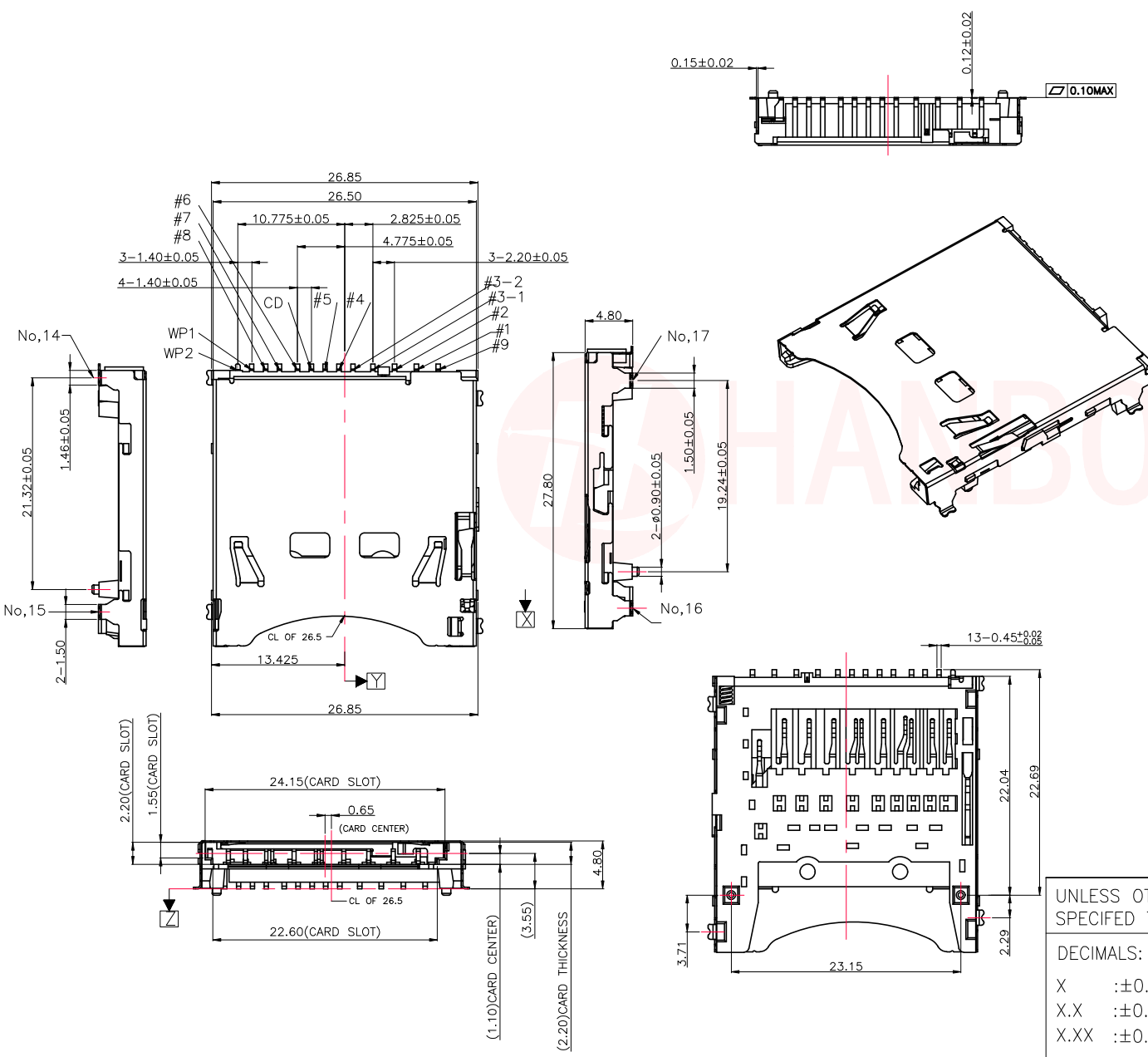




REV.	ECN NO OR DESCRIPTION	REVISED	DATE



NOTE:
 1. MATERIAL:
 1-1 PLASTICS: LCP E4711 WITH 30% GF, UL94V-0, BLACK, HF
 1-2 CONTACTS: C5210-EH THICKNESS=0.12±0.02
 1-3 SHELL: SUS301-3/4H THICKNESS=0.15±0.02
 2. PLATING:
 2-1 CONTACTS:
 2-1-1 CONTACT AREA: (1u")MIN Gold PLATING ON CONTACT AREA
 PLATING OVER NI 50u" MIN
 2-1-2 SOLDER TALL AREA: MATTE-TIN 80u" MIN
 PLATING OVER NI 50u" MIN
 2-2 SHELL:
 2-2-1 1u" MIN GOLD PLATED ON SOLDER TALLS
 50u" MIN. NICKEL UNDERPLATING OVER ALL
 3. CONTACT AND TALL COPLANARITY TO BE 0.10mm MAX.
 4. PART MUST COMPLY TAI SOL HF WD-3-1-091 SPECIFICATION

	WRITE PROTECT SWITCH		CARD DETECT SWITCH
	WRITE PROTECT POSITION	WRITE ENABLE POSITION	
CARD UN INSERTION	OPEN		OPEN
CARD HALF INSERTION		CLOSE	OPEN
CARD INSERTION	OPEN	CLOSE	CLOSE
N/O			

UNLESS OTHERWISE SPECIFIED TOLERANCES		东莞市汉博电子科技有限公司 DONGGUAN HANBO TECHNOLOGY CO., LTD			
DECIMALS: X ±0.5 X.X ±0.20 X.XX ±0.10		TITLE SD PUSH 自弹式加高垫高2.0			
ANGLES: X ±2° X.X ±1°		DWN	xiong	SD-115-B-2.0	
		CHKD	lee	SCALE:1:1	UNIT: mm
		APVD	wang	SIZE: A4	SHEET:1OF 1
		REV: A4			
CUSTOMER COPY					

